

256K X24256 32K x 8 Bit

## 400kHz 2-Wire Serial EEPROM

#### **FEATURES**

- · 400kHz 2-wire serial interface
  - —Schmitt trigger input noise suppression
  - Output slope control for ground bounce noise elimination
- Longer battery life with lower power
  - -Active read current less than 1mA
  - -Active write current less than 3mA
  - —Standby current less than 1µA
- 2.5V to 5.5V power supply
- 64-byte page write mode
  - -Minimizes total write time per word
- Internally organized 32K x 8
- Bidirectional data transfer protocol
- Self-timed write cycle
  - —Typical write cycle time of 5ms
- High reliability
  - -Endurance: 100,000 cycles
  - —Data retention: 100 years
- 8-lead XBGA
- 8-lead SOIC
- 14-lead TSSOP

#### DESCRIPTION

The X24256 is a CMOS Serial EEPROM, internally organized 32K x 8. The device features a serial interface and software protocol allowing operation on a simple two wire bus.

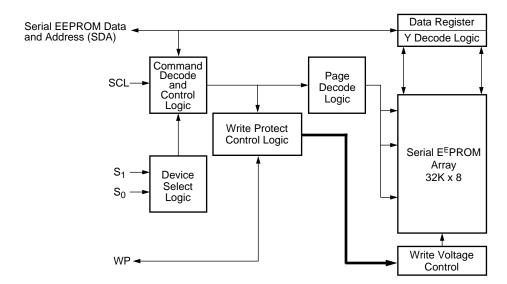
Two device select inputs  $(S_0-S_1)$  allow up to 4 devices to share a common two wire bus.

These pins have internal pull downs, so they are read as LOW if not connected.

A WP pin, when pulled HIGH prevents any nonvolatile writes to the array. When not connected WP is pulled LOW, so the device is not normally protected.

Xicor EEPROMs are designed and tested for applications requiring extended endurance. Inherent data retention is greater than 100 years.

## **BLOCK DIAGRAM**



#### PIN DESCRIPTIONS

## Serial Clock (SCL)

The SCL input is used to clock all data into and out of the device.

## Serial Data (SDA)

SDA is a bidirectional pin used to transfer data into and out of the device. It is an open drain output and may be wire-ORed with any number of open drain or open collector outputs.

An open drain output requires the use of a pull-up resistor. For selecting typical values, refer to the Pull-up resistor selection graph at the end of this data sheet.

## Device Select (S<sub>0</sub>, S<sub>1</sub>)

The device select inputs  $(S_0, S_1)$  are used to set bits in the slave address. This allows up to four devices to share a common bus. These inputs can be static or actively driven. If used statically they must be tied to  $V_{SS}$  or  $V_{CC}$  as appropriate. If actively driven, they must be driven with CMOS levels (driven to  $V_{CC}$  or  $V_{SS}$ ) and they must be constant between each start and stop issued on the SDA bus. These pins have an active pull down internally and will be sensed as low if the pin is left unconnected.

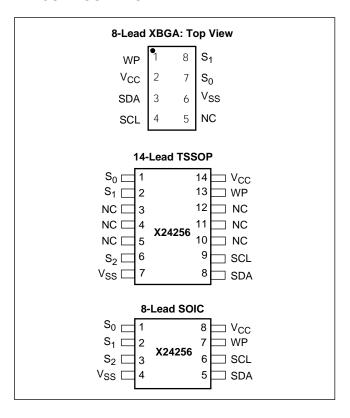
# Write Protect (WP)

WP must be constant between each start and stop issued on the SDA bus and is always active (not gated). The WP pin has an active pull down to disable the write protection when the input is left floating. The Write Protect input controls the Hardware Write Protect feature. When held LOW, Protection is disabled and the device operates normally. When this input is held HIGH, the device is protected, preventing changes to any and all locations in the EEPROM array.

#### **PIN NAMES**

Symbol	Description
S <sub>0</sub> , S <sub>1</sub>	Device Select Inputs
SDA	Serial Data
SCL	Serial Clock
WP	Write Protect
V <sub>SS</sub>	Ground
V <sub>CC</sub>	Supply Voltage
NC	No Connect

## **PIN CONFIGURATION**



#### **DEVICE OPERATION**

The device supports a bidirectional bus oriented protocol. The protocol defines any device that sends data onto the bus as a transmitter, and the receiving device as the receiver. The device controlling the transfer is a master and the device being controlled is the slave. The master will always initiate data transfers, and provide the clock for both transmit and receive operations. Therefore, the device will be considered a slave in all applications.

#### **Clock and Data Conventions**

Data states on the SDA line can change only during SCL LOW. SDA state changes during SCL HIGH are reserved for indicating start and stop conditions. Refer to Figures 1 and 2.

## **Start Condition**

All commands are preceded by the start condition, which is a HIGH to LOW transition of SDA when SCL is HIGH. The device continuously monitors the SDA and SCL lines for the start condition and will not respond to any command until this condition has been met.

Figure 1. Data Validity

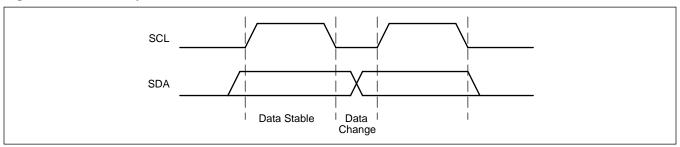
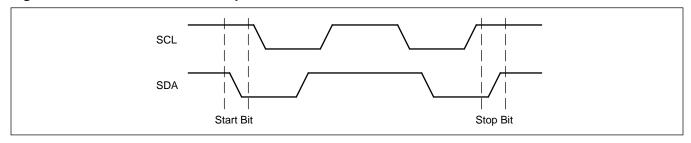


Figure 2. Definition of Start and Stop



## **Stop Condition**

All communications must be terminated by a stop condition, which is a LOW to HIGH transition of SDA when SCL is HIGH. The stop condition is also used to place the device into the standby power mode after a read sequence. A stop condition can only be issued after the transmitting device has released the bus.

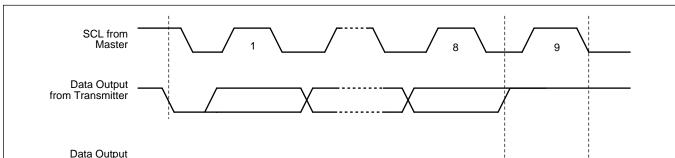
## **Acknowledge**

Acknowledge is a software convention used to indicate successful data transfer. The transmitting device, either master or slave, will release the bus after transmitting eight bits. During the ninth clock cycle the receiver will pull the SDA line LOW to acknowledge that it received the eight bits of data. Refer to Figure 3.

The device will respond with an acknowledge after recognition of a start condition and its slave address. If both the device and a write operation have been selected, the device will respond with an acknowledge after the receipt of each subsequent 8-bit word.

In the read mode the device will transmit eight bits of data, release the SDA line and monitor the line for an acknowledge. If an acknowledge is detected and no stop condition is generated by the master, the device will continue to transmit data. If an acknowledge is not detected, the device will terminate further data transmissions. The master must then issue a stop condition to return the device to the standby power mode and place the device into a known state.

Figure 3. Acknowledge Response From Receiver SCL from Master



#### **DEVICE ADDRESSING**

from Receiver

Following a start condition, the master must output the address of the slave it is accessing. The first four bits of the Slave Address Byte are the device type identifier bits. These must equal "1010". The next bit is a "0". The following 2 bits are the device select bits '0', S<sub>1</sub> and S<sub>0</sub>. This allows up to 4 devices to share a single bus. These bits are compared to the S<sub>0</sub> and S<sub>1</sub> device select input pins. The last bit of the Slave Address Byte defines the operation to be performed. When the R/W bit is a one, then a read operation is selected. When it is zero then a write operation is selected. Refer to Figure 4. After loading the Slave Address Byte from the SDA bus, the device compares the device type bits with the value "1010" and the device select bits with the status of the device select input pins. If the compare is not successful, no acknowledge is output during the ninth clock cycle and the device returns to the standby mode.

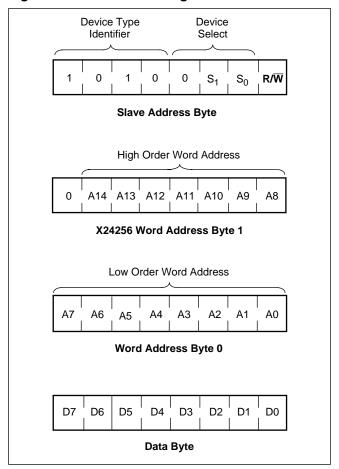
Start

On power up the internal address is undefined, so the first read or write operation must supply an address.

The word address is either supplied by the master or obtained from an internal counter, depending on the operation. The master must supply the two Word Address Bytes as shown in Figure 4.

The internal organization of the E<sup>2</sup> array is 512 pages by 64-bytes per page. The page address is partially contained in the Word Address Byte 1 and partially in bits 7 through 6 of the Word Address Byte 0. The byte address is contained in bits 5 through 0 of the Word Address Byte 0. See Figure 4.

Figure 4. Device Addressing



Acknowledge

#### WRITE OPERATIONS

## **Byte Write**

For a write operation, the device follows "3 byte" protocol, consisting of one Slave Address Byte, one Word Address Byte 1, and the Word Address Byte 0, which gives the master access to any one of the words in the array. Upon receipt of the Word Address Byte 0, the device responds with an acknowledge, and waits for the first eight bits of data. After receiving the 8 bits of the data byte, the device again responds with an acknowledge. The master then terminates the transfer by generating a stop condition, at which time the device begins the internal write cycle to the nonvolatile memory. While the internal write cycle is in progress the device inputs are disabled and the device will not respond to any requests from the master. The SDA pin is at high impedance. See Figure 5.

## **Page Write**

The device is capable of a 64 byte page write operation. It is initiated in the same manner as the byte write operation; but instead of terminating the write operation after the first data word is transferred, the master can

transmit up to sixty-three more words. The device will respond with an acknowledge after the receipt of each word, and then the byte address is internally incremented by one. The page address remains constant. When the counter reaches the end of the page, it "rolls over" and goes back to the first byte of the current page. This means that the master can write 64-bytes to the page beginning at any byte. If the master begins writing at byte 32, and loads 64-bytes, then the first 32-bytes are written to bytes 32 through 63, and the last 16 words are written to bytes 0 through 31. Afterwards, the address counter would point to byte 32. If the master writes more than 64-bytes, then the previously loaded data is overwritten by the new data, one byte at a time.

The master terminates the data byte loading by issuing a stop condition, which causes the device to begin the nonvolatile write cycle. As with the byte write operation, all inputs are disabled until completion of the internal write cycle. Refer to Figure 6 for the address, acknowledge, and data transfer sequence.

Figure 5. Byte Write Sequence

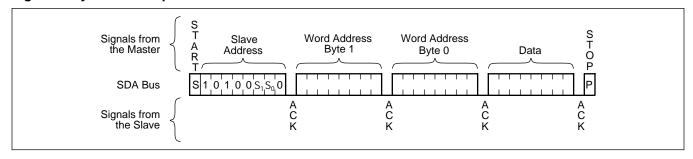
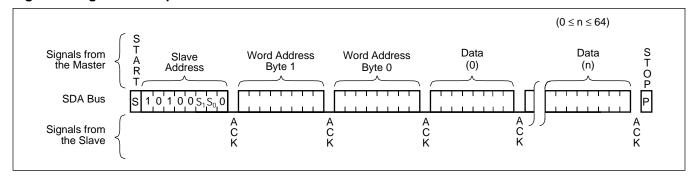


Figure 6. Page Write Sequence



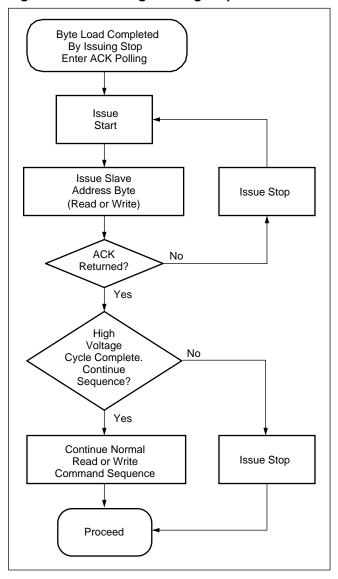
## **Stop and Write Modes**

Stop conditions that terminate write operations must be sent by the master after sending at least 1 full data byte and it's associated ACK signal. If a stop is issued in the middle of a data byte, or before 1 full data byte + ACK is sent, then the device will reset itself without performing the write. The contents of the array will not be affected.

## **Acknowledge Polling**

The maximum write cycle time can be significantly reduced using Acknowledge Polling. To initiate Acknowledge Polling, the master issues a start condition followed by the Slave Address Byte for a write or read operation. If the device is still busy with the internal write cycle, then no ACK will be returned. If the device has completed the internal write operation, an ACK will be returned and the host can then proceed with the read or write operation. Refer to Figure 7.

Figure 7. Acknowledge Polling Sequence



#### **READ OPERATIONS**

Read operations are initiated in the same manner as write operations with the exception that the R/W bit of the Slave Address Byte is set to one. There are three basic read operations: Current Address Reads, Random Reads, and Sequential Reads.

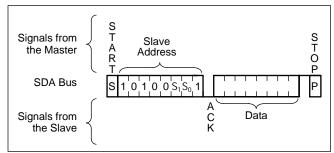
#### **Current Address Read**

Internally, the device contains an address counter that maintains the address of the last word read or written incremented by one. After a read operation from the last address in the array, the counter will "roll over" to the first address in the array. After a write operation to the last address in a given page, the counter will "roll over" to the first address on the same page.

Upon receipt of the Slave Address Byte with the R/W bit set to one, the device issues an acknowledge and then transmits the eight bits of the Data Byte. The master terminates the read operation when it does not respond with an acknowledge during the ninth clock and then issues a stop condition. Refer to Figure 8 for the address, acknowledge, and data transfer sequence.

It should be noted that the ninth clock cycle of the read operation is not a "don't care." To terminate a read operation, the master must either issue a stop condition during the ninth cycle or hold SDA HIGH during the ninth clock cycle and then issue a stop condition.

Figure 8. Current Address Read Sequence



#### Random Read

Random read operation allows the master to access any memory location in the array. Prior to issuing the Slave Address Byte with the  $R/\overline{W}$  bit set to one, the master must first perform a "Dummy" write operation. The master issues the start condition and the Slave Address Byte with the R/W bit low, receives an acknowledge, then issues the Word Address Byte 1, receives another acknowledge, then issues the Word Address Byte 0. After the device acknowledges receipt of the Word Address Byte 0, the master issues another start condition and the Slave Address Byte with the R/W bit set to one. This is followed by an acknowledge and then eight bits of data from the device. The master terminates the read operation by not responding with an acknowledge and then issuing a stop condition. Refer to Figure 9 for the address, acknowledge, and data transfer sequence.

The device will perform a similar operation called "Set Current Address" if a stop is issued instead of the second start shown in Figure 9. The device will go into standby mode after the stop and all bus activity will be ignored until a start is detected. The effect of this operation is that the new address is loaded into the address counter, but no data is output by the device.

The next Current Address Read operation will read from the newly loaded address.

## **Sequential Read**

Sequential reads can be initiated as either a current address read or random read. The first Data Byte is transmitted as with the other modes; however, the master now responds with an acknowledge, indicating it requires additional data. The device continues to output data for each acknowledge received. The master terminates the read operation by not responding with an acknowledge and then issuing a stop condition.

The data output is sequential, with the data from address n followed by the data from address n + 1. The address counter for read operations increments through all byte addresses, allowing the entire memory contents to be read during one operation. At the end of the address space the counter "rolls over" to address 0000h and the device continues to output data for each acknowledge received. Refer to Figure 10 for the acknowledge and data transfer sequence.

Figure 9. Random Read Sequence

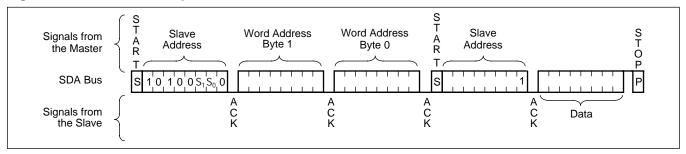
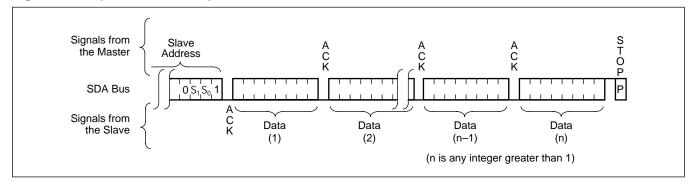


Figure 10. Sequential Read Sequence



## **ABSOLUTE MAXIMUM RATINGS**

Temperature under bias X2425665°C to +135°C
Storage Temperature65°C to +150°C
Voltage on any pin with
respect to V <sub>SS</sub> –1V to +7V
D.C. output current5mA

## COMMENT

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; functional operation of the device (at these or any other conditions above those indicated in the operational sections of this specification) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## RECOMMENDED OPERATING CONDITIONS

Temperature	Min.	Max.
Commercial	0°C	+70°C
Industrial	-40°C	+85°C

Supply Voltage	Limits
X24256-2.5	2.5V to 5.5V

# $\textbf{D.C. OPERATING CHARACTERISTICS} \ \lor_{CC} \ \text{equals the range indicated for each device type, unless otherwise stated.}$

		V <sub>CC</sub> = 2.	5 to 5.5V		
Symbol	Parameter	Min.	Max.	Unit	Test Conditions
I <sub>CC1</sub>	Active Supply Current (Read)		1	mA	$V_{IL} = V_{CC} \times 0.1, V_{IH} = V_{CC} \times 0.9,$ $f_{SCL} = 400kHz, SDA = Open$
I <sub>CC2</sub>	Active Supply Current (Write)		3	mA	
I <sub>SB1</sub> <sup>(2)</sup>	Standby Current AC		1	mA	$V_{IL} = V_{CC} \times 0.1, V_{IH} = V_{CC} \times 0.9,$ $f_{SCL} = 400 \text{kHz}, SDA = Open$
V <sub>SB</sub>	Standby Voltage (Test)	V <sub>CC</sub> – 0.2		V	
I <sub>SB2</sub> <sup>(2)</sup>	Standby Current DC		1	mA	$V_{SDA} = V_{SCL} = V_{SB}$ , Others = GND or $V_{SB}$
ILI	Input Leakage Current		10	mA	V <sub>IN</sub> = GND to V <sub>CC</sub>
I <sub>LO</sub>	Output Leakage Current		10	mA	$V_{SDA}$ = GND to $V_{CC}$ , Device is in Standby <sup>(2)</sup>
V <sub>IL</sub> <sup>(3)</sup>	Input LOW Voltage	-0.5	V <sub>CC</sub> x 0.3	V	
V <sub>IH</sub> <sup>(3)</sup>	Input HIGH Voltage	V <sub>CC</sub> x 0.7	V <sub>CC</sub> + 0.5	V	
V <sub>HYS</sub>	Schmitt Trigger Input Hysteresis Fixed input level	0.2		V	
	V <sub>CC</sub> related level	V <sub>CC</sub> x 0.05		V	
V <sub>OL</sub>	Output LOW Voltage		0.4	V	I <sub>OL</sub> = 3mA

# **CAPACITANCE** $T_A = +25$ °C, f = 1MHz, $V_{CC} = 5$ V

Symbol	Parameter	Max.	Unit	Test Conditions
C <sub>I/O</sub> (3)	Input/Output Capacitance (SDA)	8	pF	V <sub>I/O</sub> = 0V
C <sub>IN</sub> <sup>(3)</sup>	Input Capacitance (S <sub>0</sub> , S <sub>1</sub> , SCL, WP)	6	pF	V <sub>IN</sub> = 0V

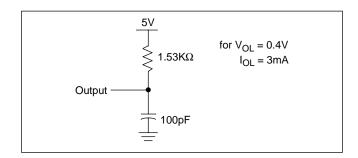
Notes: (1) The device enters the Active state after any start, and remains active until: 9 clock cycles later if the Device Select Bits in the Slave Address Byte are incorrect; 200ns after a stop ending a read operation; or t<sub>WC</sub> after a stop ending a write operation.

- (2) The device goes into Standby: 200ns after any stop, except those that initiate a high voltage write cycle; t<sub>WC</sub> after a stop that initiates a high voltage cycle; or 9 clock cycles after any start that is not followed by the correct Device Select Bits in the Slave Address Byte.
- (3)  $V_{IL}$  Min. and  $V_{IH}$  Max. are for reference only and are not tested.

## A.C. CONDITIONS OF TEST

Input pulse levels	V <sub>CC</sub> x 0.1 to V <sub>CC</sub> x 0.9
Input rise and fall times	10ns
Input and output timing levels	V <sub>CC</sub> X 0.5
Output load	Standard output load

## **EQUIVALENT A.C. LOAD CIRCUIT**



## A.C. OPERATING CHARACTERISTICS (Over the recommended operating conditions, unless otherwise stated.

## **Read & Write Cycle Limits**

		V <sub>CC</sub> = 2.	5V	
Symbol	Parameter	Min.	Max.	Unit
f <sub>SCL</sub>	SCL clock frequency	0	400	kHz
t <sub>IN</sub>	Pulse width suppression time at inputs	50		ns
t <sub>AA</sub>	SCL LOW to SDA data out valid	0.1	0.9	μs
t <sub>BUF</sub>	Time the bus must be free before a new transmission can start	1.3		μs
t <sub>LOW</sub>	Clock LOW period	1.3		μs
tHIGH	Clock HIGH period	0.6		μs
t <sub>SU:STA</sub>	Start condition setup time	0.6		μs
t <sub>HD:STA</sub>	Start condition hold time	0.6		μs
t <sub>SU:DAT</sub>	Data in setup time	100		ns
t <sub>HD:DAT</sub>	Data in hold time	0		μs
t <sub>SU:STO</sub>	Stop condition setup time	0.6		μs
t <sub>DH</sub>	Data output hold time	50		ns
t <sub>R</sub>	SDA and SCL rise time	20 + .1Cb <sup>(3)</sup>	300	ns
t <sub>F</sub>	SDA and SCL fall time		300	ns
t <sub>SU:S0</sub> , S1, WP	S0, S1, and WP Setup Time	0.6		ns
t <sub>HD:S0</sub> , S1, WP	S0, S1, and WP Hold Time	0		ns
Cb	Capacitive load for each bus line		400	pF

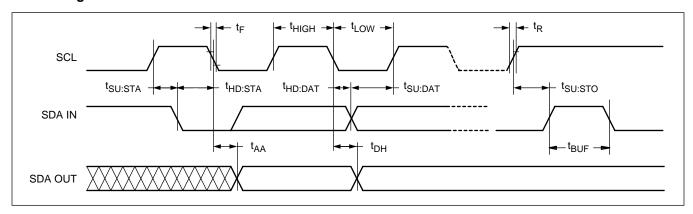
## POWER-UP TIMING(4)

Symbol	Parameter	Max.	Unit
t <sub>PUR</sub>	Power-up to Read Operation	1	ms
t <sub>PUW</sub>	Power-up to Write Operation	5	ms

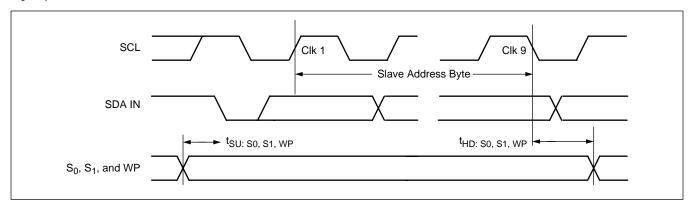
**Notes:** (4) t<sub>PUR</sub> and t<sub>PUW</sub> are the delays required from the time V<sub>CC</sub> is stable until the specified operation can be initiated. These parameters are periodically sampled and not 100% tested.

(5) Typical values are for T<sub>A</sub> = 25°C and nominal supply voltage (5V), Cb = total capacitance of one bus line in pF.

## **Bus Timing**



# S<sub>0</sub>, S<sub>1</sub>, and WP Pin Timing



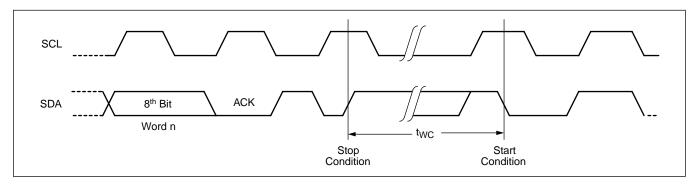
## **Write Cycle Limits**

Symbol	Parameter	Min.	Тур.	Max.	Unit
T <sub>WC</sub> <sup>(6)</sup>	Write Cycle Time	_	5	10	ms

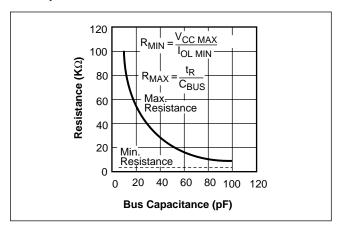
Note: (6) t<sub>WC</sub> is the minimum cycle time to be allowed from the system perspective unless polling techniques are used. It is the maximum time the device requires to automatically complete the internal write operation.

The write cycle time is the time from a valid stop condition of a write sequence to the end of the internal erase/write cycle. During the write cycle, the X24256 bus interface circuits are disabled, SDA is allowed to remain HIGH, and the device does not respond to its slave address.

# **Write Cycle Timing**



# **Guidelines for Calculating Typical Values of Bus Pull-Up Resistors**



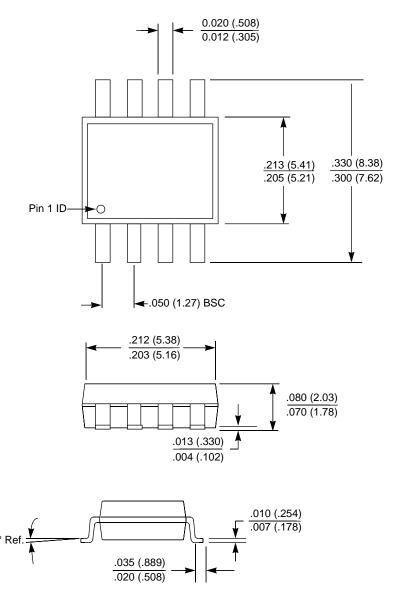
# **SYMBOL TABLE**

WAVEFORM	INPUTS	OUTPUTS
	Must be steady	Will be steady
_////	May change from Low to High	Will change from Low to High
	May change from High to Low	Will change from High to Low
	Don't Care: Changes Allowed	Changing: State Not Known
	N/A	Center Line is High Impedance

Characteristics subject to change without notice.

## **PACKAGING INFORMATION**

# 8-Lead Plastic, 0.200" Wide Small Outline Gullwing Package Typ "A" (EIAJ SOIC)

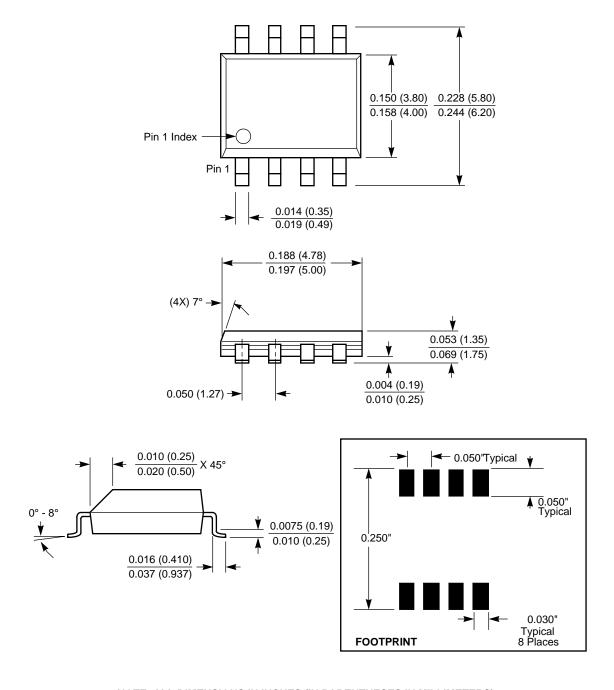


#### NOTES:

- 1. ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)
- 2. PACKAGE DIMENSIONS EXCLUDE MOLDING FLASH

# **PACKAGING INFORMATION**

# 8-Lead Plastic Small Outline Gull Wing Package Type S



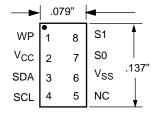
NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

# **PACKAGING INFORMATION**

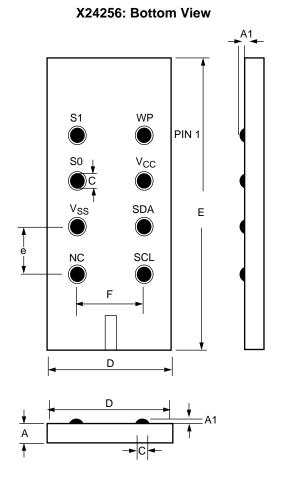
# 8-Lead XBGA

8-Lead XBGA Complete Part Number	Top Mark
X24256B-2.5	XAAI
X24256BI-2.5	XAAU

# 8-Lead XBGA: Top View



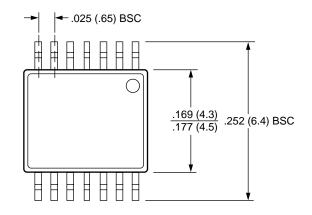
DWG Symbol	8L XBGA
Α	Contact Factory
A1	Contact Factory
С	Contact Factory
D	Contact Factory
E	Contact Factory
е	Contact Factory
F	Contact Factory

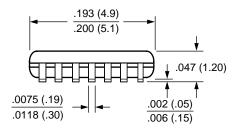


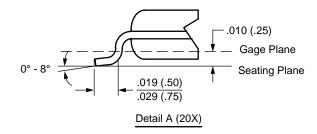
ALL DIMENSIONS IN  $\mu M$  (to convert to inches,  $1\mu m$  = 3.94 x  $10^{\text{-}5}$  inch) ALL DIMENSIONS ARE TYPICAL VALUES

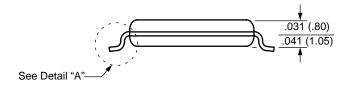
## **PACKAGINING INFORMATION**

# 14-Lead Plastic, TSSOP, Package Type V



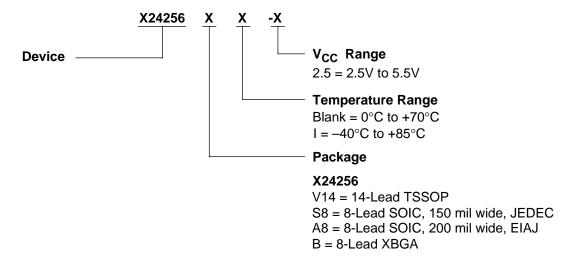




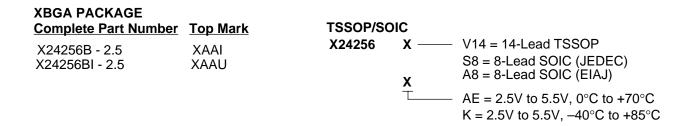


NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

## **Ordering Information**



#### **Part Mark Conventions**



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#### U.S. PATENTS

Xicor products are covered by one or more of the following U.S. Patents: 4,326,134; 4,393,481; 4,404,475; 4,450,402; 4,486,769; 4,488,060; 4,520,461; 4,533,846; 4,599,706; 4,617,652; 4,668,932; 4,752,912; 4,829,482; 4,874,967; 4,883,976; 4,980,859; 5,012,132; 5,003,197; 5,023,694; 5,084,667; 5,153,880; 5,153,691; 5,161,137; 5,219,774; 5,270,927; 5,324,676; 5,434,396; 5,544,103; 5,587,573; 5,835,409; 5,977,585. Foreign patents and additional patents pending.

#### LIFE RELATED POLICY

In situations where semiconductor component failure may endanger life, system designers using this product should design the system with appropriate error detection and correction, redundancy and back-up features to prevent such an occurrence.

Xicor's products are not authorized for use in critical components in life support devices or systems.

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.